

FreeDFM Quote Specifications

File IDentification And General Information

It is very important that you identify your files accurately. The primary reason for delayed or undelivered results would be that our automated systems can not readily identify the contents of your zip file or that a key piece of fabrication or design information is missing.

<u>Click Here</u> to see a table of package extensions and naming conventions.

Design File Information

* Please take a few moments to help us identify your files.

File Name:	File Content:				
back1r0.gbl	Bottom Copper	•			
drl1r0.drl	NC Drill	•			
drlNP1r0.drl	Draw ing/Other	•			
edge1r0.gbr	Draw ing/Other	•			
fab1r0.pho	Draw ing/Other	•			
fabNP1r0.pho	Draw ing/Other	•			
front1r0.gtl	Top Copper	•			
gnd1r0.gbr	Inner Copper	•	Positive	▼ 2	•
mback1r0.gbs	Bottom Soldermask	•			
mfmt1r0.gts	Top Soldermask	•			
pwr1r0.gbr	Inner Copper	•	Positive	▼ 3	\blacksquare
readme.txt	Draw ing/Other	•			
sback1r0.gbo	Bottom Silkscreen	•			
sfmt1r0.gto	Top Silkscreen	•			

In an effort to streamline the submission process for our FreeDFM service we have attempted to pre-identify the uploaded files using their file names. This is based on the standard naming conventions of most EDA software packages and may not always be correct. In addition to identifying any files that display "Select File Type" please confirm the proper identification of those files already identified by our system. Having all files correctly identified is critical to the proper processing thru FreeDFM and production; this will insure that you receive accurate FreeDFM results and that your board order will be fabricated correctly. As we are always striving for continuous improvement we would appreciate your feedback regarding files that were incorrectly identified or not identified (freedfm@4pcb.com).

Please enter your contact information below:

Company Name: Western Michigan University Phone: 6166136888

First Name: Donovan Last Name: Squires

Email 1: donovan.l.squires@wmich.edu

Please enter your quote specs and attributes below:

Part#	120222001	Revision#	1.0	<u>Layer C</u>	<u>ount</u>	4	•			
X Dimension	4.75	Y Dimension	4.75	<u>Array</u>						
<u>Array X Dim</u>		Array Y Dim		Array U	<u>p</u>					
<u>Tab-Rout?</u>		Scoring?								
Material Type	FR4		•							
Finish Thickness	0.062"	Finish Plating	Lead Free Sc	lder 🔻 <u>Gold</u>	<u>d Fingers</u>	None	•			
Soldermask Side	s Both Sides 🔻	Soldermask C	<u>olor</u> Green	▼ Cop	per Wt. (O	uter) 1 oz	•			
<u>Silkscreen Sides</u>	Top Side ▼	Silkscreen Col	<u>or</u> White	▼ Cop	<u>per Wt. (In</u>	<u>ner)</u> 1 oz	\blacksquare			
Certifications & IPC Class 2										
Vias:	Blind/Buried Via	s? None	Via-In-Pad?	None	•					
Microvias? None										
	Soldermask	<u> Plugged Vias?</u>								
Additional	Controlled D	<u>Dielectric?</u>								
Attributes:	Controlled Impedance? (Pricing Subject To File Review)									
	Plated Slots? Plated Edges? (Pricing Subject To File Review)									
	<u>Counterbores?</u> #Plated #Non-Plated									
	Countersink		# Non	-Plated						
	Castellated		astellated Hol	e Size						
Quantities:	5 10	50 150	<u>ITAR</u>	O Yes O No						
Comments:										
_							1			

Submit